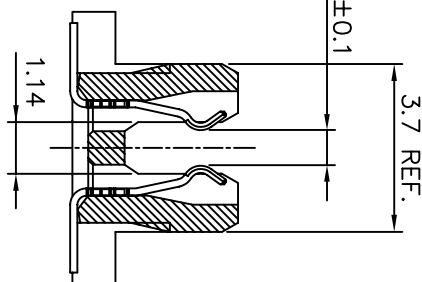
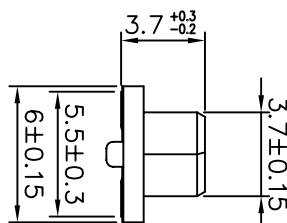
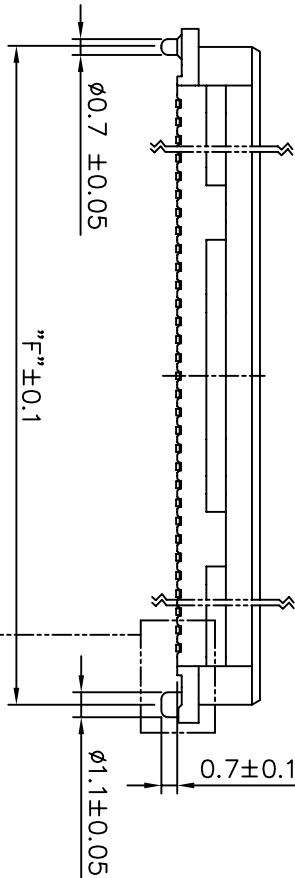
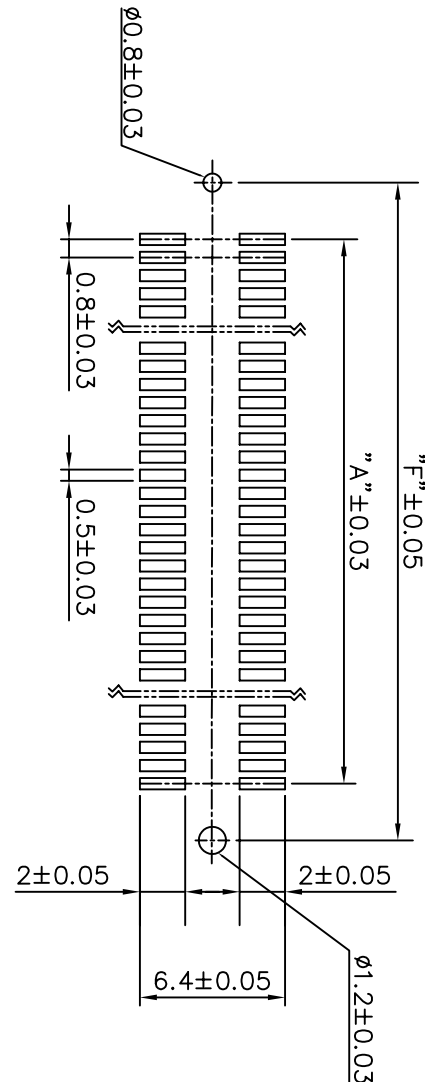
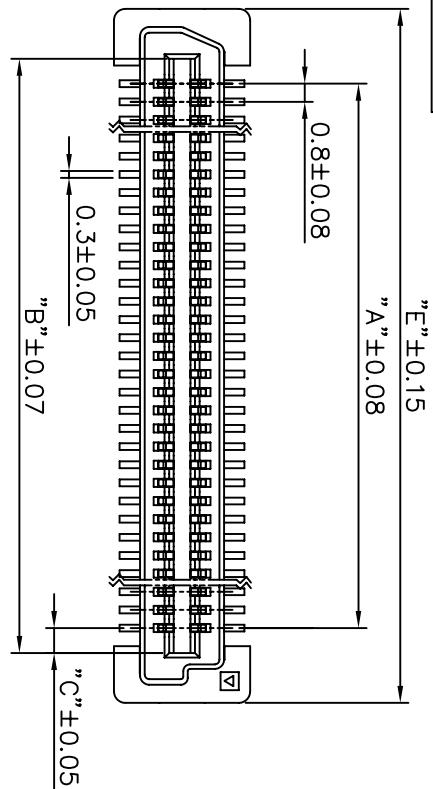


PRODUCT NO.
73277-XX1XXXXXX



SEC. Z-Z (2X)

NOTE: RECOMMENDED TRANSITION BOARD
THICKNESS IS $1.0 \pm 0.05 \text{ MM}$

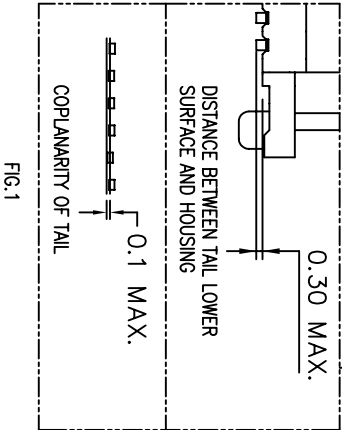


FIG.1

mat'l. code	ec'n no	dr	date	surface	tolerance	projection	product family
				ISO 1302	ISO 406 ISO 1101		BERGSTAK
				tolerances unless otherwise specified			
Itr				angles	± 0.38		title
G	T03-0103	MW	4/3/03	linear	± 0.25	mm	0.8mm BOARD TO BOARD
H	T03-0214	MW	06/10/03				MOD. RECEPTACLE ASS'Y
J	T03-0379	MW	09/04/03	$0 \pm 2^\circ$	± 0.15	scale 1:1	
K	T04-0094	MW	03/05/04	dr			dwg no
L	S04-0133	MW	06/24/04	engr			sheet 1 of 2 size
M	S04-0251	CH	11/23/04	chr			A4
N	S06-0196	MC	07/04/06	ppd			type
Sheet	revision	N	L				Product Customer Drawing
index	sheet	1	2				

NUMBER OF POSITIONS	08	2 X 40	31.2	37.8	36.2	33.15	0.98
	10	2 X 50	39.2	45.8	44.2	41.4	1.1

	HOLD DOWN
0	NONE

PACKAGING	
0	STICK
1	TAPE & REEL WITHOUT CAP
2	TAPE & REEL WITH CAP
9	STICK WITH CAP
8	TAPE & REEL WITH KAPTON

	COLOR
NONE	BLACK, 16-659-012 OR 16-522-016
<u>1</u>	NATURAL, 16-522-015
<u>1F</u> (note 6)	BLACK, 16-659-012 OR 16-522-016 (For Lead Free Plating Option 4, 5 and 6)
<u>1LF</u> (note 6)	NATURAL, 16-522-015 (For Lead Free Plating Option 4, 5 and 6)

	PLATING
0	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.2 umMIN. ON CONTACT AREA
1	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.1 umMIN OVER PALLADIUM-NICKEL ALLOY :0.76umMIN ON CONTACT AREA
4	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.2 umMIN. ON CONTACT AREA SOLDER AREA PLATED PURE TIN 2.5um MIN.
5	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.38 umMIN ON CONTACT AREA SOLDER AREA PLATED PURE TIN 2.5um MIN.
6	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.1 umMIN OVER PALLADIUM-NICKEL ALLOY :0.76umMIN ON CONTACT AREA SOLDER AREA PLATED PURE TIN 2.5um MIN.

NOTES:

- 1.MATERIAL
- HOUSING:G.F.LCP UL94V-0
- COLOR: AS TABLE SHOWN.
- TERMINAL:BERYLLIUM COPPER.
- 2.PLATING
- AS TABLE SHOWN.
- 3.PACKAGING
- SEE NO. GS-14-551 FOR PACKAGING SPECIFICATION.
- 4.SEE GS-12-148 FOR PRODUCT SPECIFICATION.
- 5.TAIL COPLANARITY
- DISTANCE BETWEEN TAIL LOWER SURFACE
AND HOUSING:SEE FIG.1.
- COPLANARITY TO BE 0.1 MAX.
- ⑥ THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVE
AND OTHER COUNTRY REGULATIONS AS DESCRIBED
IN GS-22-008
7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260 °C
FOR 10 SECS IN A CONNECTION, INFRA-RED OR
VAPOR PHASE REFLOW OVEN

mat'l. code		surface		tolerance		projection		product family	
		ISO 1302		ISO 406 ISO 1001				BERGSTAK	
itr ecn no dr		date		tolerances unless otherwise specified				title	
K				.03-0.38		mm		0.8mm BOARD TO BOARD	
L	S06-0196	MC	07/04/06	.00±0.25		← mm →		MOD. RECEPTACLE ASS'Y	
				0±.27		scale 1:1		dwg no	
				.000±0.15				sheet2 of 2	
				dr				size	
				dr				A4	
				engrt YU WEN CHU					
				chr CHEN HONG					
				ppd NG JOEY					
sheet		revision						type	
index		sheet						Product Customer Drawing	